PRESS RELEASE

BE Semiconductor Industries N.V. Announces 2026 Third Quarter Conference Call and Audio Webcast Details

Duiven, the Netherlands, October 15, 2026 - BE Semiconductor Industries N.V. (“the Company” or "Besi"), (Euronext Amsterdam: BESI; OTC: BESIY), a leading manufacturer of assembly equipment for the semiconductor industry, will release its results for the third quarter ended September 30, 2026, on Thursday October 22, 2026, at 7.00 a.m. CET (1.00 a.m. EDT).

Besi will host a conference call and audio webcast on Thursday October 22, 2026, at 4.00 p.m. CET (10.00 a.m. EDT). Details can be found on Besi’s website.

About Besi

Besi is a leading manufacturer of assembly equipment supplying a broad portfolio of advanced packaging solutions to the semiconductor and electronics industries. We offer customers high levels of accuracy, reliability and throughput at a lower cost of ownership with a principal focus on wafer level and substrate assembly solutions. Customers are primarily leading semiconductor manufacturers, foundries, assembly subcontractors and electronics and industrial companies. Besi’s ordinary shares are listed on Euronext Amsterdam (symbol: BESI). Its Level 1 ADRs are listed on the OTC markets (symbol: BESIY) and its headquarters are located in Duiven, the Netherlands. For more information, please visit our website at www.besi.com.

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